



# AP503

## DCS-band 4W HBT Amplifier Module

### Product Features

- 1805 – 1880 MHz
- 32.2 dB Gain
- +25 dBm CDMA2k 7fa Power (-64 dBc ACPR)
- +12 V Single Supply
- Power Down Mode
- Bias Current Adjustable
- RoHS-compliant flange-mount pkg

### Applications

- Final stage amplifiers for Repeaters
- Optimized for driver amplifier PA mobile infrastructure

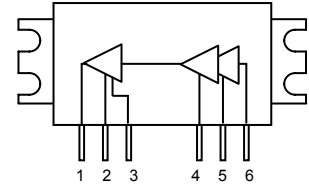
### Product Description

The AP503 is a high dynamic range power amplifier in a RoHS-compliant flange-mount package. The multi-stage amplifier module has 31.5 dB gain. The module has been internally optimized for linearity to provide +25 dBm (-64 dBc ACPR) linear power for 7-carrier CDMA2000 applications.

The AP503 uses a high reliability InGaP/GaAs HBT process technology and does not require any external matching components. The module operates off of a +12V supply and does not requiring any negative biasing voltages; an internal active bias allows the amplifier to maintain high linearity over temperature. It has the added feature of a +5V power down control pin. While the module has been tuned for optimal performance for Class AB applications, the quiescent current can also be adjusted for Class B applications through an external resistor. A low-cost metal housing allows the device to have a low thermal resistance and achieves over 100 years MTTF. All devices are 100% RF and DC tested.

The AP503 is targeted for use as a driver or final stage amplifier in wireless infrastructure where high linearity and high power is required. This combination makes the device an excellent candidate for next generation multi-carrier 3G base stations using the DCS1800 frequency band.

### Functional Diagram



Top View

| Pin No. | Function  |
|---------|-----------|
| 1       | RF Output |
| 2 / 4   | Vcc       |
| 3 / 5   | Vpd       |
| 6       | RF Input  |
| Case    | Ground    |

### Specifications <sup>(1)</sup>

25 °C, V<sub>cc</sub>=12V, V<sub>pd</sub>=5V, I<sub>cq</sub>=835mA, R<sub>7</sub>=0Ω, 50Ω unmatched fixture

| Parameter                                         | Units | Min         | Typ   | Max  | Test Conditions                                                               |
|---------------------------------------------------|-------|-------------|-------|------|-------------------------------------------------------------------------------|
| Operational Bandwidth                             | MHz   | 1805 – 1880 |       |      |                                                                               |
| Test Frequency                                    | MHz   | 1845        |       |      |                                                                               |
| Adjacent Channel Power Ratio                      | dBc   |             | -63.8 | -61  | CDMA2000 7fa 25 dBm Total Power, 885 kHz offset<br>P <sub>out</sub> = +25 dBm |
| Power Gain                                        | dB    | 29.5        | 32.2  | 34.5 |                                                                               |
| Input Return Loss                                 | dB    |             | 11    |      |                                                                               |
| Output Return Loss                                | dB    |             | 6     |      |                                                                               |
| Output P1dB                                       | dBm   |             | +36   |      |                                                                               |
| Output IP3                                        | dBm   |             | +50   |      | P <sub>out</sub> = +23 dBm/tone, Δf = 1 MHz                                   |
| Operating Current <sup>(2)</sup>                  | mA    | 790         | 850   | 940  | P <sub>out</sub> = +25 dBm                                                    |
| Quiescent Current, I <sub>cq</sub> <sup>(2)</sup> | mA    | 780         | 835   | 920  |                                                                               |
| Device Voltage, V <sub>cc</sub>                   | V     |             | +12   |      |                                                                               |
| Device Voltage, V <sub>pd</sub>                   | V     |             | +5    |      |                                                                               |
| Load Stability                                    | VSWR  | 10:1        |       |      | Pull-down voltage: 0V = "OFF", 5V="ON"                                        |

1. Test conditions unless otherwise noted: 25°C.

2. The current can be adjusted through an external resistor from the 5V supply to the pull-down voltage pin (pin 3).

### Absolute Maximum Rating

| Parameter                                                     | Rating         |
|---------------------------------------------------------------|----------------|
| Operating Case Temperature                                    | -40 to +85 °C  |
| Storage Temperature                                           | -55 to +150 °C |
| RF Input Power (continuous)<br>with output terminated in 50 Ω | +15 dBm        |

Operation of this device above any of these parameters may cause permanent damage.

### Ordering Information

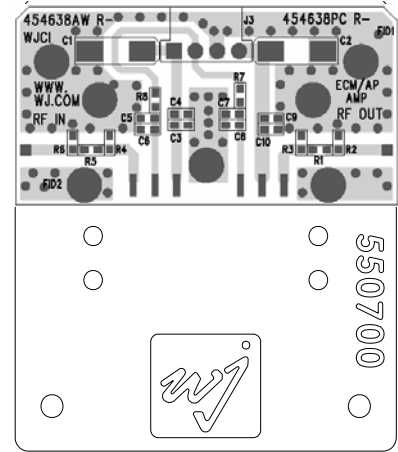
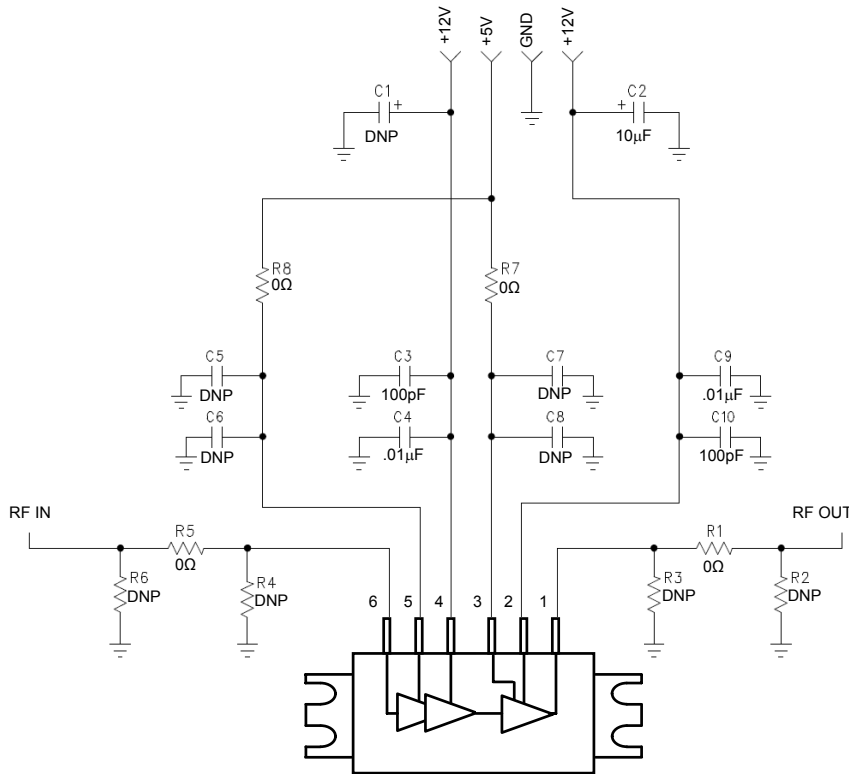
| Part No.  | Description                                                                          |
|-----------|--------------------------------------------------------------------------------------|
| AP503     | DCS-band 4W HBT Amplifier Module                                                     |
| AP503-PCB | Fully-Assembled Evaluation Board<br>(Class AB configuration, I <sub>cq</sub> =835mA) |

Specifications and information are subject to change without notice



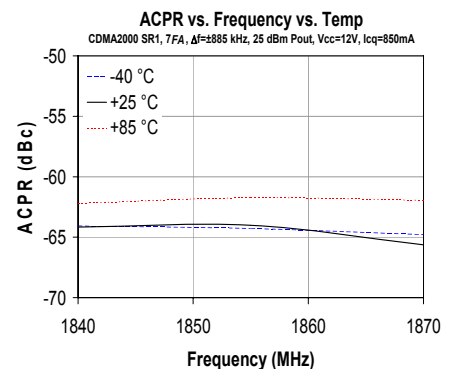
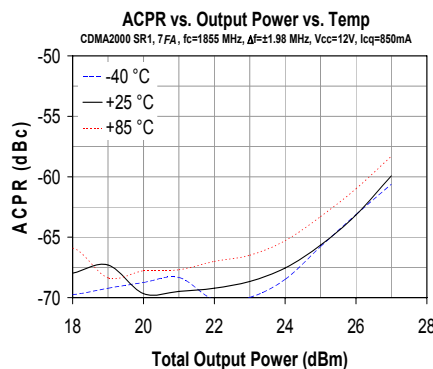
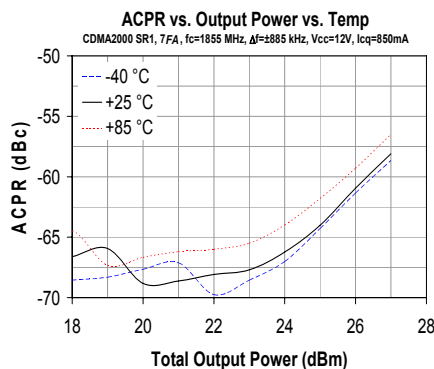
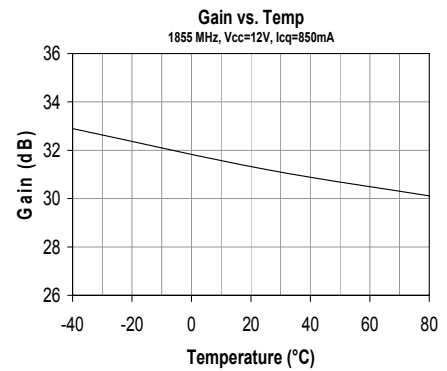
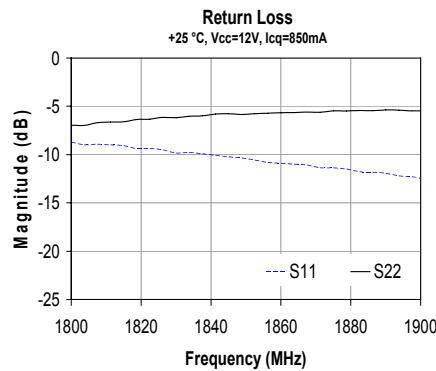
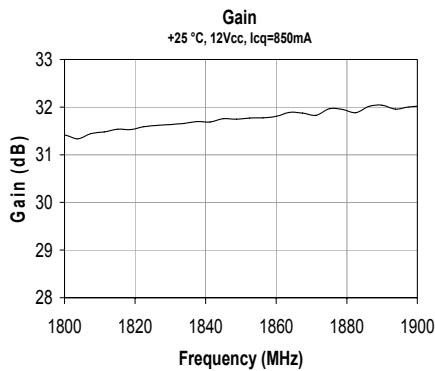
## Performance Graphs – Class AB Configuration (AP503-PCB)

The AP503-PCB and AP503 module is configured for Class AB by default. The resistor – R7 – which sets the current draw for the amplifier is set at 0 Ω in this configuration. Increasing that value will decrease the quiescent and operating current of the amplifier module, as described on the next page.



#### Notes:

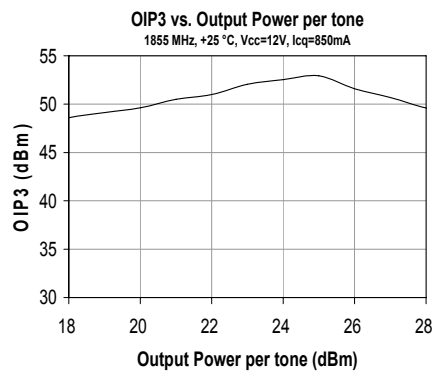
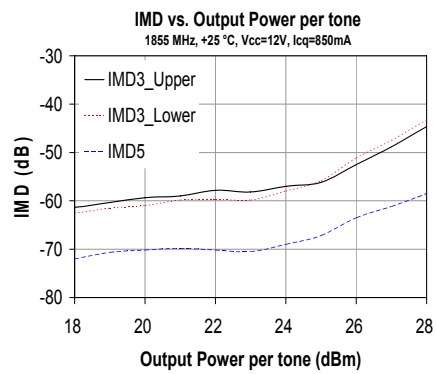
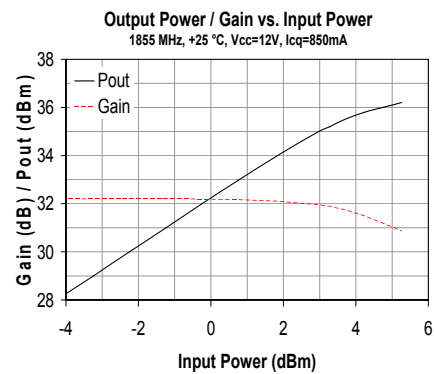
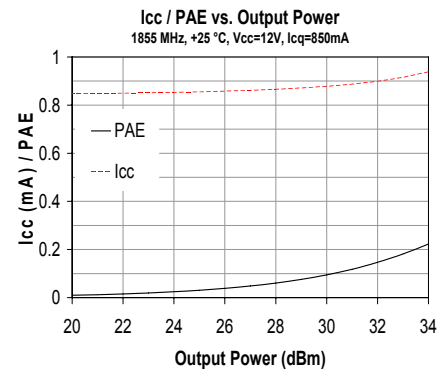
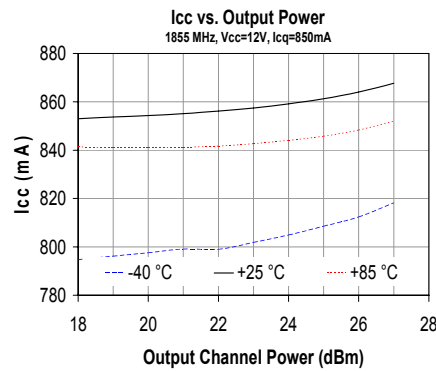
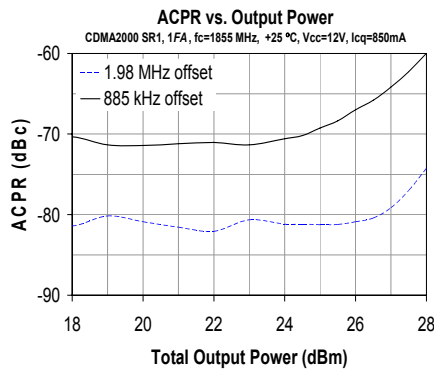
- Please note that for reliable operation, the evaluation board will have to be mounted to a much larger heat sink during operation and in laboratory environments to dissipate the power consumed by the device. The use of a convection fan is also recommended in laboratory environments. Details of the mounting holes used in the WJ heatsink are given on the last page of this datasheet.
- The area around the module underneath the PCB should not contain any soldermask in order to maintain good RF grounding.
- For proper and safe operation in the laboratory, the power-on sequencing should be followed:
  - Connect RF In and Out
  - Connect the voltages and ground pins as shown in the circuit.
  - Apply the RF signal
  - Power down with the reverse sequence



Specifications and information are subject to change without notice



### Performance Graphs (cont'd)





### MTTF Calculation

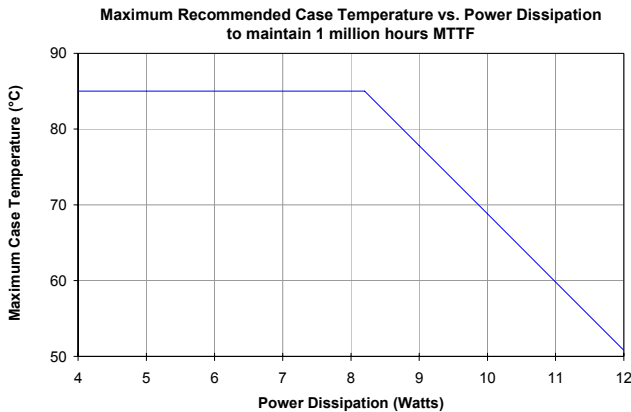
The MTTF of the AP503 can be calculated by first determining how much power is being dissipated by the amplifier module. Because the device's intended application is to be a power amplifier pre-driver or final stage output amplifier, the output RF power of the amplifier will help lower the overall power dissipation. In addition, the amplifier can be biased with different quiescent currents, so the calculation of the MTTF is custom to each application.

The power dissipation of the device can be calculated with the following equation:

$$P_{diss} = V_{cc} * I_{cc} - (\text{Output RF Power} - \text{Input RF Power}),$$

$V_{cc}$  = Operating supply voltage = **12V**  
 $I_{cc}$  = Operating current  
 {The RF power is converted to Watts}

While the maximum recommended case temperature on the datasheet is listed at 85 °C, it is suggested that customers maintain an MTTF above 1 million hours. This would convert to a derating curve for maximum case temperature vs. power dissipation as shown in the plot below.



To calculate the MTTF for the module, the junction temperature needs to be determined. This can be easily calculated with the module's power dissipation, the thermal resistance value, and the case temperature of operation:

$$T_j = P_{diss} * R_{th} + T_{case}$$

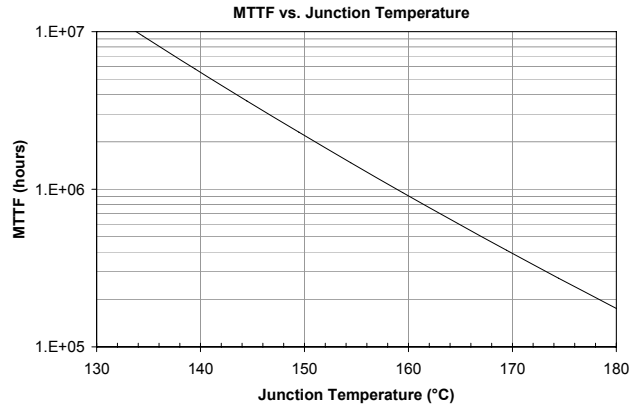
$T_j$  = Junction temperature  
 $P_{diss}$  = Power dissipation (calculated from above)  
 $R_{th}$  = Thermal resistance = **9 °C/W**  
 $T_{case}$  = Case temperature of module's heat sink

From a numerical standpoint, the MTTF can be calculated using the Arrhenius equation:

$$MTTF = A * e^{(E_a/k/T_j)}$$

$A$  = Pre-exponential Factor = **6.087 x 10<sup>-11</sup> hours**  
 $E_a$  = Activation Energy = **1.39 eV**  
 $k$  = Boltzmann's Constant = **8.617 x 10<sup>-5</sup> eV/°K**  
 $T_j$  = Junction Temperature (°K) =  $T_j$  (°C) + 273

A graphical view of the MTTF can be shown in the plot below.





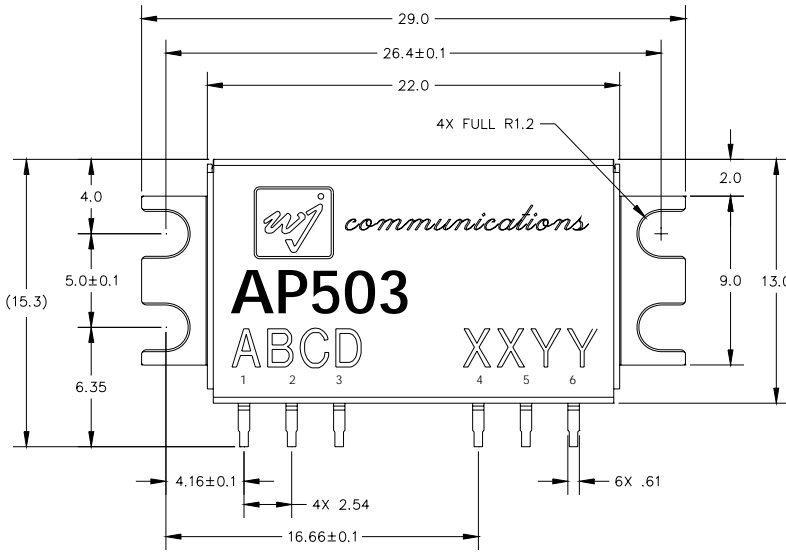
# AP503

DCS-band 4W HBT Amplifier Module

The Communications Edge™

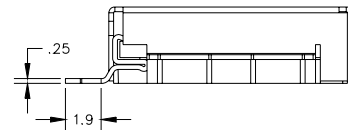
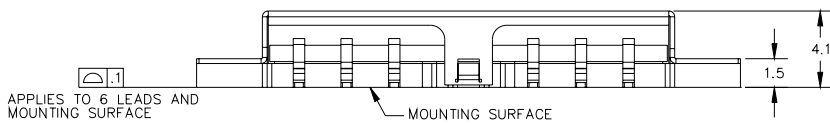
Product Information

## Outline Drawing

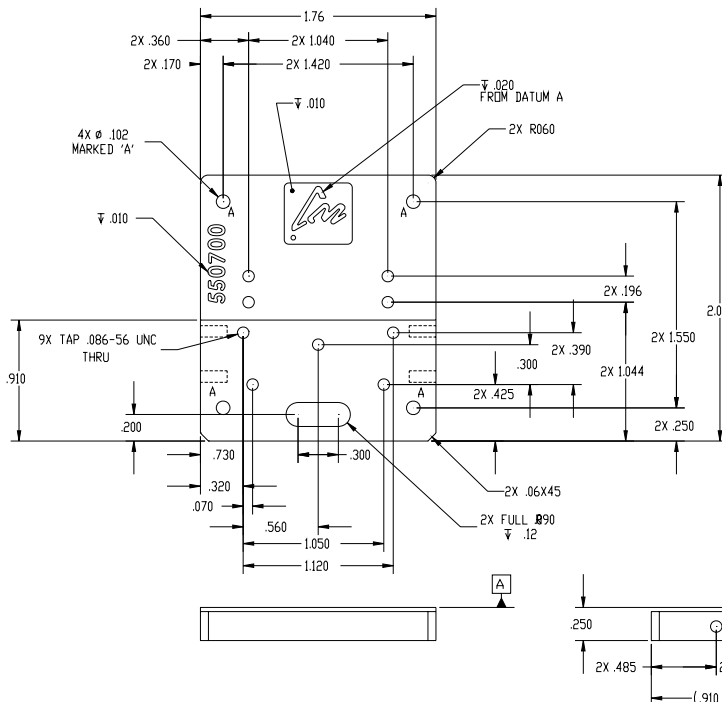


### NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ANSI Y14.4M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS (INCHES). ANGLES ARE IN DEGREES.
3. PIN ASSIGNMENTS:  
 [PIN 1] RF OUT  
 [PIN 2] +12 Vcc  
 [PIN 3] Vpd  
 [PIN 4] +12 Vcc  
 [PIN 5] Vpd  
 [PIN 6] RF IN  
 [CASE] GROUND



## Outline Drawing for the Heatsink with the WJ Evaluation Board



## Product Marking

The device will be marked with an "AP503" designator with an alphanumeric lot code on the top surface of the package noted as "ABCD". A manufacturing date will also be printed as "XXYY", where the "XX" represents the week number from 1 - 52.

The product will be shipped in tubes in multiples of 15.

## ESD / MSL Information



Caution! ESD sensitive device.

ESD Rating: Class 1C  
 Value: Passes at  $\geq 1,000$  to  $< 2,000$  volts  
 Test: Human Body Model (HBM)  
 Standard: JEDEC Standard JESD22-A114

ESD Rating: Class III  
 Value: Passes  $\geq 500$  to  $< 1,000$  volts  
 Test: Charged Device Model (CDM)  
 Standard: JEDEC Standard JESD22-C101